FAIRCHILD

SEMICONDUCTOR TM

74LVT244 • 74LVTH244 Low Voltage Octal Buffer/Line Driver with 3-STATE Outputs

General Description

The LVT244 and LVTH244 are octal buffers and line drivers designed to be employed as memory address drivers, clock drivers and bus oriented transmitters or receivers which provide improved PC board density.

The LVTH244 data inputs include bushold, eliminating the need for external pull-up resistors to hold unused inputs.

These octal buffers and line drivers are designed for low-voltage (3.3V) V_{CC} applications, but with the capability to provide a TTL interface to a 5V environment. The LVT244 and LVTH244 are fabricated with an advanced BiCMOS technology to achieve high speed operation similar to 5V ABT while maintaining low power dissipation.

Features

- \blacksquare Input and output interface capability to systems at 5V $\rm V_{CC}$
- Bushold data inputs eliminate the need for external pull-up resistors to hold unused inputs (74LVTH244), also available without bushold feature (74LVT244)

July 1999

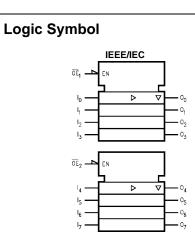
Revised November 2000

- Live insertion/extraction permitted
- Power Up/Down high impedance provides glitch-free bus loading
- Outputs source/sink -32 mA/+64 mA
- Functionally compatible with the 74 series 244
- Latch-up performance exceeds 500 mA
- ESD performance:
- Human-body model > 2000V Machine model > 200V
 - Charged-device model > 1000V

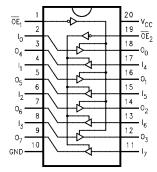
Ordering Code:

Order Number	Package Number	Package Description
74LVT244WM	M20B	20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300 Wide
74LVT244SJ	M20D	20-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
74LVT244MSA	MSA20	20-Lead Shrink Small Outline Package (SSOP), EIAJ TYPE II, 5.3mm Wide
74LVT244MTC	MTC20	20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
74LVTH244WM	M20B	20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300 Wide
74LVTH244SJ	M20D	20-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
74LVTH244MSA	MSA20	20-Lead Shrink Small Outline Package (SSOP), EIAJ TYPE II, 5.3mm Wide
74LVTH244MTC	MTC20	20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
Device also available in	Tape and Reel. Specify by	y appending suffix letter "X" to the ordering code.

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Connection Diagram



Pin Descriptions

Pin Names	Description
$\overline{OE}_1, \overline{OE}_2$	3-STATE Output
	Enable Inputs
I ₀ —I ₇	Inputs
O ₀ -O ₇	Output

Truth Tables

Inp	outs	Outputs			
OE ₁	I _n	(Pins 12, 14, 16, 18)			
L	L	L			
L	н	н			
Н	х	Z			
Inp	outs	Outputs			
OE ₂	I _n	(Pins 3, 5, 7, 9)			
	1	L			
L	-				
L	н	н			

H = HIGH Voltage Level L = LOW Voltage Level X = Immaterial Z = High Impedance

Symbol	Parameter	Value	Conditions	Units
V _{CC}	Supply Voltage	-0.5 to +4.6		V
VI	DC Input Voltage	-0.5 to +7.0		V
Vo	DC Output Voltage	-0.5 to +7.0	Output in 3-STATE	V
		-0.5 to +7.0	Output in HIGH or LOW State (Note 2)	V
I _{IK}	DC Input Diode Current	-50	V _I < GND	mA
I _{OK}	DC Output Diode Current	-50	V _O < GND	mA
I _O	DC Output Current	64	V _O > V _{CC} Output at HIGH State	mA
		128	V _O > V _{CC} Output at LOW State	mA
I _{CC}	DC Supply Current per Supply Pin	±64		mA
I _{GND}	DC Ground Current per Ground Pin	±128		mA
T _{STG}	Storage Temperature	-65 to +150		°C

Recommended Operating Conditions

Symbol	Parameter	Min	Max	Units
V _{CC}	Supply Voltage	2.7	3.6	V
VI	Input Voltage	0	5.5	V
I _{ОН}	HIGH-Level Output Current		-32	mA
OL	LOW-Level Output Current		64	IIIA
T _A	Free-Air Operating Temperature	-40	85	°C
Δt/ΔV	Input Edge Rate, V _{IN} = 0.8V–2.0V, V _{CC} = 3.0V	0	10	ns/V

Note 1: Absolute Maximum continuous ratings are those values beyond which damage to the device may occur. Exposure to these conditions or conditions beyond those indicated may adversely affect device reliability. Functional operation under absolute maximum rated conditions is not implied. Note 2: I_O Absolute Maximum Rating must be observed.

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74LVT244 • 74LVTH244

DC Electrical Characteristics								
	I Parameter			T _A =-40°C to +85°C				
Symbol			V _{CC} (V)	Min	Typ (Note 3)	Мах	Units	Conditions
V _{IK}	Input Clamp Diode Volta	ge	2.7			-1.2	V	I _I = -18 mA
V _{IH}	Input HIGH Voltage		2.7–3.6	2.0			V	$V_0 \le 0.1V$ or
V _{IL}	Input LOW Voltage		2.7–3.6			0.8	v	$V_O \ge V_{CC} - 0.1V$
V _{OH}	Output HIGH Voltage		2.7–3.6	V _{CC} -0.2			V	$I_{OH} = -100 \ \mu A$
			2.7	2.4			V	I _{OH} = -8 mA
			3.0	2.0			V	$I_{OH} = -32 \text{ mA}$
V _{OL}	Output LOW Voltage		2.7			0.2	V	I _{OL} = 100 μA
			2.7			0.5	V	I _{OL} = 24 mA
			3.0			0.4	V	I _{OL} = 16 mA
			3.0			0.5	V	I _{OL} = 32 mA
			3.0			0.55	V	I _{OL} = 64 mA
I _{I(HOLD)}	Bushold Input Minimum Drive		3.0	75			μΑ	$V_I = 0.8V$
(Note 4)				-75			μΑ	V _I = 2.0V
I _{I(OD)}	Bushold Input Over-Drive Current to Change State		3.0	500			μΑ	(Note 5)
(Note 4)				-500			μΑ	(Note 6)
I _I	Input Current		3.6			10	μΑ	$V_I = 5.5V$
		Control Pins	3.6			±1	μΑ	$V_I = 0V \text{ or } V_{CC}$
		Data Pins	3.6			-5	μΑ	$V_I = 0V$
		Data Filis	5.0			1	μΑ	$V_I = V_{CC}$
I _{OFF}	Power Off Leakage Curr		0			±100	μΑ	$0V \le V_1 \text{ or } V_0 \le 5.5V$
I _{PU/PD}	Power up/down 3-STATE	E	0–1.5V			±100	μA	$V_0 = 0.5V$ to 3.0V
	Output Current					100	μΛ	$V_I = GND \text{ or } V_{CC}$
I _{OZL}	3-STATE Output Leakag		3.6			-5	μΑ	$V_O = 0.5V$
I _{OZH}	3-STATE Output Leakag	e Current	3.6			5	μΑ	$V_{O} = 3.0V$
I _{OZH} +	3-STATE Output Leakag	e Current	3.6			10	μΑ	$V_{CC} < V_O \le 5.5V$
I _{CCH}	Power Supply Current		3.6			0.19	mA	Outputs HIGH
I _{CCL}	Power Supply Current		3.6			5	mA	Outputs LOW
I _{CCZ}	Power Supply Current		3.6			0.19	mA	Outputs Disabled
I _{CCZ} +	Power Supply Current		3.6			0.19	mA	$V_{CC} \le V_O \le 5.5V$,
								Outputs Disabled
ΔI_{CC}	Increase in Power Supp	ly Current	3.6			0.2	mA	One Input at V _{CC} – 0.6V
	(Note 7)							Other Inputs at V _{CC} or GND

Note 3: All typical values are at V_{CC} = 3.3V, T_A = 25^{\circ}C.

Note 4: Applies to bushold versions only (74LVTH244).

Note 5: An external driver must source at least the specified current to switch from LOW-to-HIGH.

Note 6: An external driver must sink at least the specified current to switch from HIGH-to-LOW.

Note 7: This is the increase in supply current for each input that is at the specified voltage level rather than V_{CC} or GND.

Dynamic Switching Characteristics (Note 8)

Symbol	Parameter	V _{CC}	$T_A = 25^{\circ}C$			Units	Conditions	
Symbol	Faiametei	(V)	Min	Тур	Max	Units	$\textbf{C}_{\textbf{L}}=\textbf{50}~\textbf{pF},~\textbf{R}_{\textbf{L}}=\textbf{500}\Omega$	
V _{OLP}	Quiet Output Maximum Dynamic V _{OL}	3.3		0.8		V	(Note 9)	
V _{OLV}	Quiet Output Minimum Dynamic V _{OL}	3.3		-0.8		V	(Note 9)	

Note 8: Characterized in SOIC package. Guaranteed parameter, but not tested.

Note 9: Max number of outputs defined as (n). n-1 data inputs are driven 0V to 3V. Output under test held LOW.

AC Electrical Characteristics

Symbol	Decomotor						
	Parameter	Min	Typ (Note 10)	Max	Min	Max	Units
t _{PLH} t _{PHL}	Propagation Delay Data to Output	1.1		3.8 3.9	1.1 1.3	4.0 4.2	ns
t _{PZH}	Output Enable Time	1.1		4.5 4.4	1.1 1.4	5.3 5.0	ns
t _{PHZ} t _{PLZ}	Output Disable Time	1.9 1.8		4.9 4.4	1.9 1.8	5.1 4.4	ns
t _{OSHL} t _{OSLH}	Output to Output Skew (Note 11)			1.0		1.0	ns

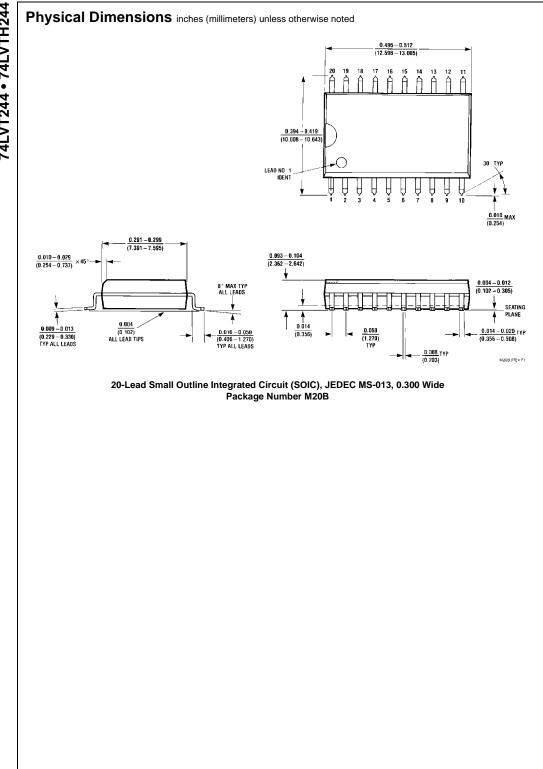
Note 10: All typical values are at V_{CC} = 3.3V, T_A = 25°C.

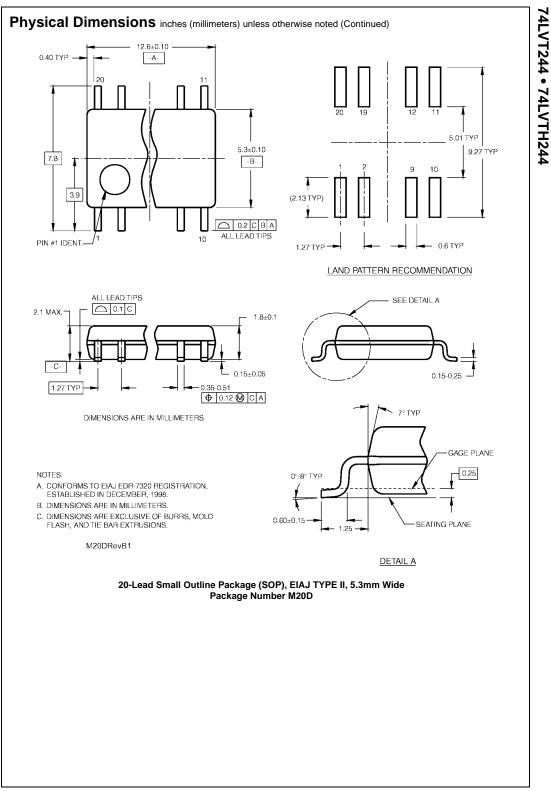
Note 11: Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (t_{OSHL}) or LOW-to-HIGH (t_{OSLH}). Parameter guaranteed by design.

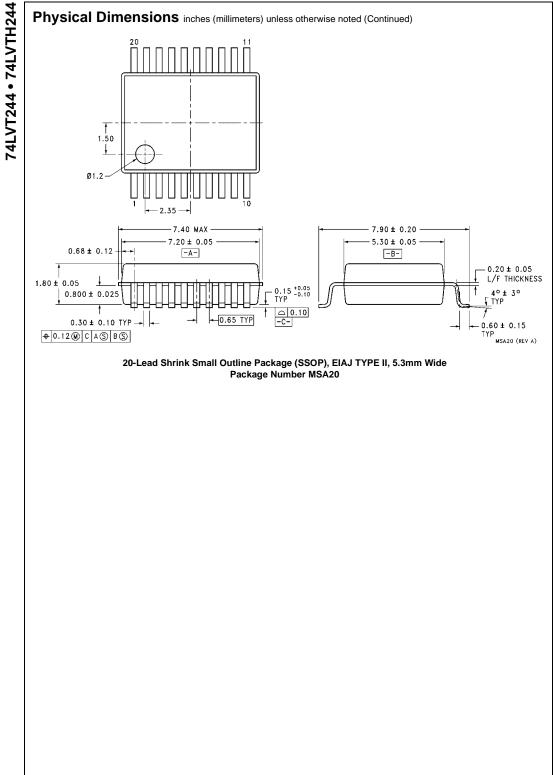
Capacitance (Note 12)

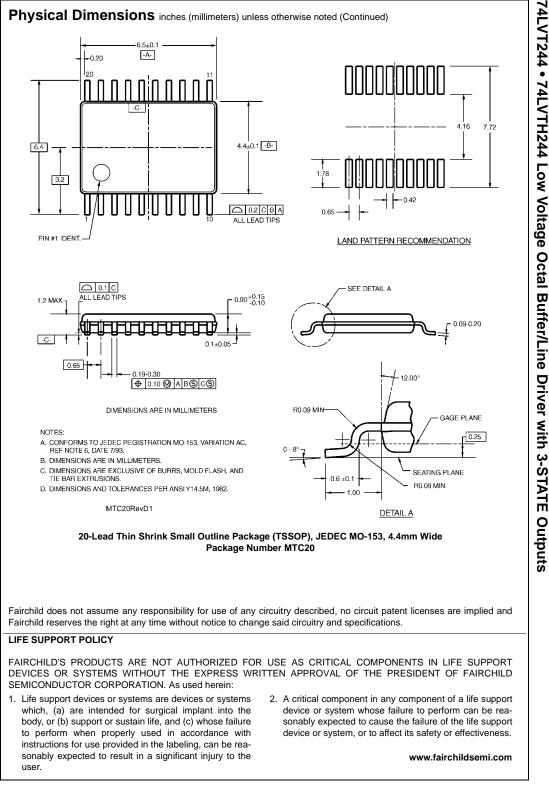
Parameter	Conditions	Typical	Units	
Input Capacitance	$V_{CC} = 0V$, $V_I = 0V$ or V_{CC}	3	pF	
Output Capacitance	$V_{CC} = 3.0V, V_O = 0V \text{ or } V_{CC}$	6	pF	
	Input Capacitance	Input Capacitance $V_{CC} = 0V, V_I = 0V \text{ or } V_{CC}$	Input Capacitance $V_{CC} = 0V, V_I = 0V \text{ or } V_{CC}$ 3	

Note 12: Capacitance is measured at frequency f = 1 MHz, per MIL-STD-883, Method 3012.









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